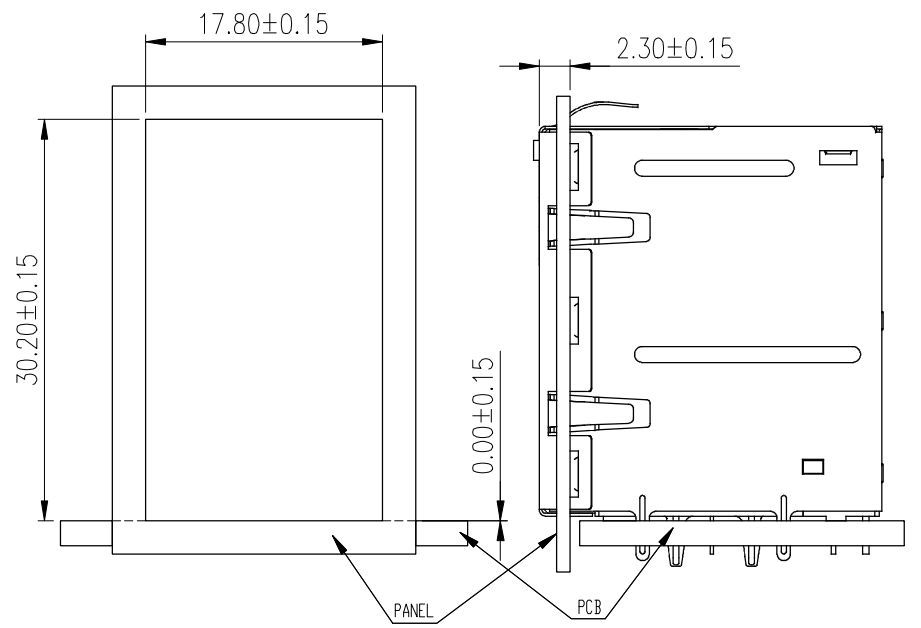
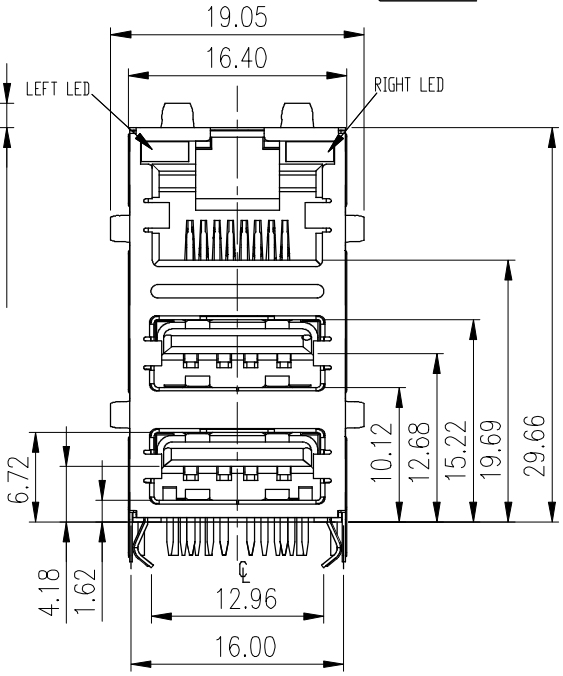
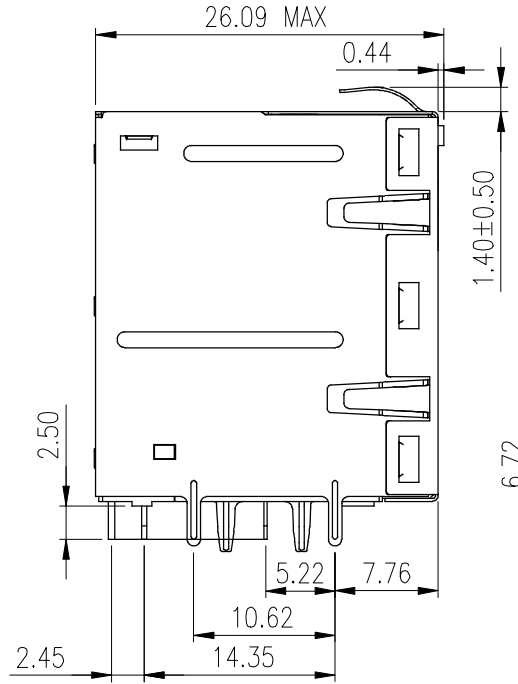
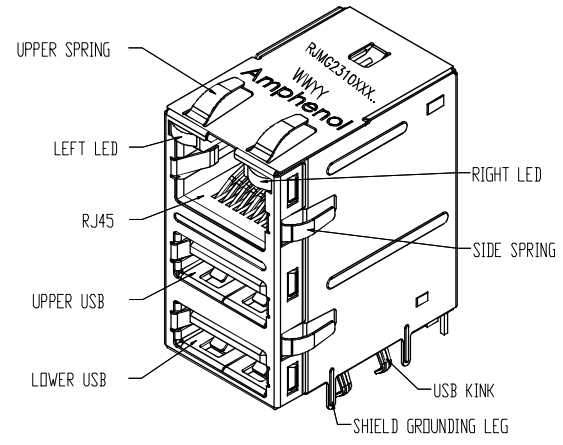
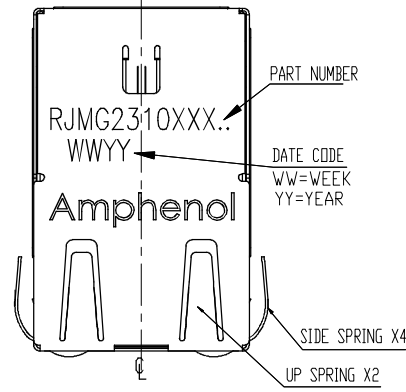


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The marking on this product doesn't contain environmental hazardous materials per Material Specification SS-00259 for Sony GP compliant or per directive 2011/65/EU for RoHS compliant.

CUSTOMER DRAWING

REVISIONS				
SYM	ECN No.	DESCRIPTION	DATE	APPROVED
A		NEW PROPOSAL DRAWING	04/10/2008	Greg.L
B	NE-15160	ADD THE PANEL DIMENSION AND UPDATE THE SHAPE	12/01/2015	Roger Tsai
C	NE-17008	Update the Footprint of USB PCB Layout	1/10/2017	Roger Tsai



TOLERANCE	APPROVALS	DATE	TITLE		Amphenol®							
X. ±0.35	DRAWN Arvin Ye	1/10/2017	RJmag 1000 Base-T		Amphenol Corporation							
X.X ±0.25			RJ Over Dual USB		Amphenol Taiwan Corporation							
X.XX ±0.15	CHECKED Vivian Wen	1/10/2017			PART No.	RJMG2310228A0ER						
ANGULAR ±1°	APPROVED Roger Tsai	1/10/2017			SHEET	1 OF 4						
UNLESS OTHERWISE SPECIFIED	DWG TYPE CUST DWG	PROJECT CODE RJMG			UNIT	mm	SIZE	A3	DWG No.	RJMG2310228A0ER	REV.	C
					SCALE	NA						

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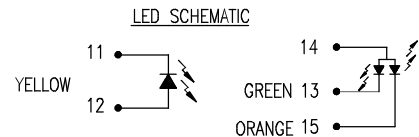
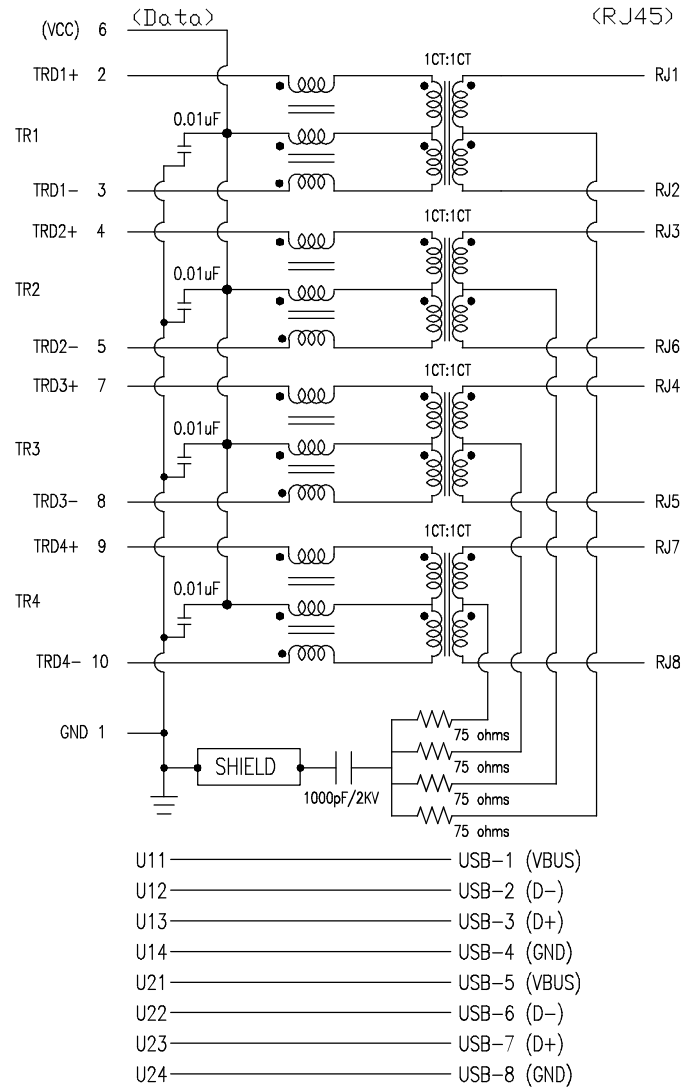
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CUSTOMER DRAWING

Compliant with IEEE 802.3ab Standard

REVISIONS				
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C	NE-17008	Update the Footprint of USB PCB Layout	1/10/2017	Roger Tsai

SCHEMATIC DRAWING



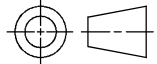
CONNECTOR PERFORMANCE

ELECTRICAL SPECIFICATION(@25° C)

PARAMETER	LIMITS (MAX. OR MIN.)	FREQUENCY RANGE/TEST CONDITIONS
INSERTION LOSS	-1.2dB MAX.	0.1-125 MHz
RETURN LOSS	-16dB MIN. -10+20 log(f/80MHz)dB MIN.	0.5-40 MHz 40-100 MHz
CM-CM REJECTION	-30dB MIN.	100KHz-100MHz
CM-DM REJECTION	-35dB MIN.	100KHz-100MHz
CROSSTALK	-35dB MIN.	100KHz-100MHz
HIPOT (Withstanding)	1.5kVrms/60Hz or 2.25VDC MIN.	60S
ISOLATION Resistance	1000M ohms MIN.	500VDC 60S
OCL	350uH MIN. From 0~70 degree	100KHz 100mV 8mA
TURN RATIO	1:1±5%	

LED PERFORMANCE:

	Activity	Link	
		Green (10Mbps)	Orange (100Mbps)
Display Color	Yellow	Green	Orange
Wavelength	590nm	565nm	605nm
Forward Current	30mA	30mA	30mA
Reverse Current	10uA	10uA	10uA
Forward Volt.Max	2.6VDC	2.6VDC	2.6VDC

TOLERANCE	APPROVALS	DATE	TITLE		Amphenol®				
X. ±0.35 X.X ±0.25 X.XX ±0.15	DRAWN	Arvin Ye	1/10/2017	RJmag 1000 Base-T		Amphenol Corporation Amphenol Taiwan Corporation			
	CHECKED	Vivian Wen	1/10/2017	RJ Over Dual USB					
	ANGULAR ±1°	APPROVED	Roger Tsai	1/10/2017			UNIT mm	SIZE A3	PART No. RJMG2310228A0ER
UNLESS OTHERWISE SPECIFIED	DWG TYPE	CUST DWG	PROJECT CODE	RJMG	SCALE NA	SHEET 3 OF 4	DWG No. RJMG2310228A0ER	REV. C	

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CUSTOMER DRAWING

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C	NE-17008	Update the Footprint of USB PCB Layout	1/10/2017	Roger Tsai

MATERIALS:

HOUSING DIELECTRIC MATERIAL:

POLYMER TYPE: HIGH TEMPERATURE GLASS-REINFORCED THERMOPLASTIC,
 COLOR: BLACK
 UL FLAMMABILITY RATING : UL 94V-0

CONTACTS (RJ MAG):

BASE METAL ALLOY: PHOSPHOR BRONZE
 PLATING: 30u 'Au Min OVER 50u 'Ni Min UNDERPLATING
 100u 'Tin Min OVER 50u ' Ni MIN ON TAILS.

SHIELD:

STAINLESS STEEL , SUS304-1/2H. T=0.2MM , NO PLATING

MECHANICAL FEATURES:

SOLDERABILITY: MIL-STD-202, METHOD 208.

MATING/UNMATING FORCE:

USB PORT :

COMPLY WITH USB2.0 FOR ALL ELECTRICAL AND MECHANICAL CHARACTERISTICS
 INSERTION FORCE 3.5Kg MAX, PER USB2.0 SPEC
 WITHDRAWAL FORCE 1.0Kg MIN , PER USB2.0 SPEC
 DURABILITY: 5000 CYCLES MIN

RJ PORT :

MATING: 2.0Kg MAX , PER EIA-364-13B
 UNMATING FORCE: 2.0Kg MAX , PER EIA-364-13B
 PACKAGING: 40PCS/PLASTIC TRAY, 4 TRAYS/BOX
 COMPLY WITH FCC PART 68 SUBPART F.
 DURABILITY: 5000 CYCLES MIN

Environmental

OPERATING TEMPERATURE: -40°C TO +85°C.

STORAGE TEMPERATURE: -40°C TO +100°C.

WAVE SOLDERING TEMPERATURE: 260°C FOR 10 SECONDS MAX

ALTITUDE OPERATING RANGE: SEA LEVEL TO 3000m

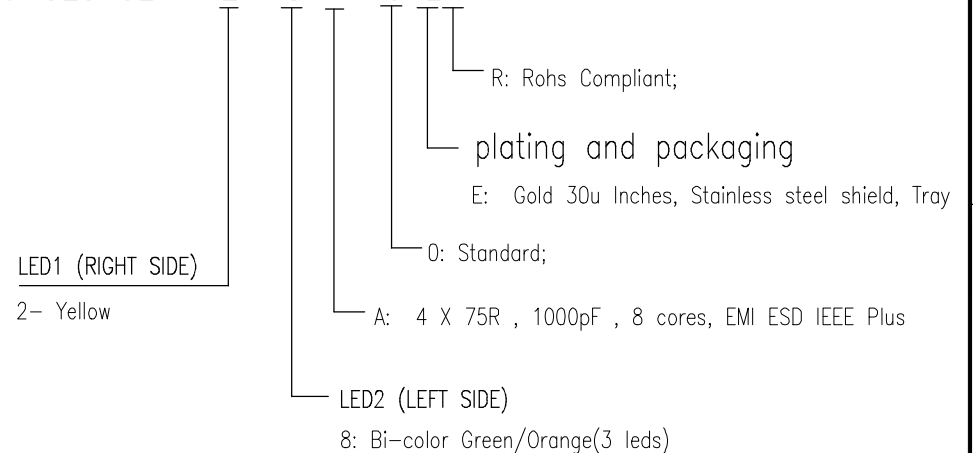
HUMIDITY: NO DAMAGE OR CHANGE THAT AFFECTS THE FUNCTION OR LOOKS OF MATED CONNECTORS

THERMAL SHOCK: SUBJECT MATED CONNECTORS TO 10 CYCLES BETWEEN -55°C AND 85°C, EVERY STEP TEMPERATURE 0.5h MIN

MECHANICAL SHOCK: THREE SHOCKS IN EACH DIRECTION SHALL BE APPLIED ALONG THREE MUTUALLY PERPENDICULAR AXES OF THE TEST SPECIMEN (18 SHOCKS)

REMARKED:

RJMG23102 - 2 - 8 A - 0 ER



TOLERANCE		APPROVALS		DATE	TITLE		Amphenol®				
X.		DRAWN	Arvin Ye	1/10/2017	RJmag 1000 Base-T		Amphenol Corporation				
X.X	±0.35	CHECKED	Vivian Wen	1/10/2017	RJ Over Dual USB		Amphenol Taiwan Corporation				
X.XX	±0.25	APPROVED	Roger Tsai	1/10/2017		UNIT	mm	SIZE	A3	PART No.	RJMG2310228A0ER
X.XXX	±0.15	DWG TYPE	CUST DWG	PROJECT CODE		RJMG	SCALE	NA	SHEET	4 OF 4	DWG No.
ANGULAR ±1°		UNLESS OTHERWISE SPECIFIED								REV.	C